SILICON (Si) POWER MOSFET A CEP45N65S



CEP45N65S

650V ▲ 56mΩ ▲ 45A ▲ Si MOSFET

SILICON Si MOSFET ▲ THT type N-channel enhancement mode UL94V-0 rated flame retardant epoxy TO220-3L package Super high dense cell density for extremely low R_{DS(ON)} High power and current handling capability

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HALOGEN

FREE



Parameter (T _c = 25°C, unless otherwise noted)		Characteristics
Drain-Source Voltage	V _{DS}	650V
Gate-Source Voltage	V _{GS}	±30V
Continuous Drain Current at T _c = 25°C	Ι _D	45A
Continuous Drain Current at T _c = 100°C	Ι _D	28A
Pulsed Drain Current Note 1	IDM Note 5	180A
Maximum Power Dissipation at $T_c = 25^{\circ}C$	PD	357W
Power Dissipation Derating above 25°C	ΔΡ _D	2.8W/°C
Single Pulsed Avalanche Energy Note 6	E _{AS}	300mJ
Single Pulsed Avalanche Current Note 6	I _{AS}	4A
Operating and Storage Temperature Range	T _J , T _{STG}	-55°C to +150°C

THERMAL CHARACTERISTICS

Parameter	Symbol	Limit
Thermal Resistance, Junction-to-Case	R _{TH_JC}	0.35°C/W
Thermal Resistance, Junction-to-Ambient	R _{th_ja}	62.5°C/W

APPLICATIONS



PIN DESCRIPTION

Circuit Diagram	Outline - Front View	Pin No.	Description
G (1)		1	Gate
G (1)		2	Drain
S (3)		3	Source

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ELECTRICAL CHARACTERISTICS A T_c = 25°C, unless otherwise noted

Item	Condition	Symbol	Min.	Тур.	Max.	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	$V_{GS} = 0V$, $I_D = 250\mu A$	BV _{DSS}	650			V
Zero Gate Voltage Drain Current	$V_{DS} = 650V, V_{GS} = 0V$	I _{DSS}			1	μΑ
Gate Body Leakage Current, Forward	$V_{GS} = 30V$, $V_{DS} = 0V$	I _{GSSF}			100	nA
Gate Body Leakage Current, Reverse	V_{GS} = -30V, V_{DS} = 0V	I _{GSSR}			-100	nA
On Characteristics Note 2						
Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 250 \mu A$	V _{GS(th)}	2.5		4.5	V
Static Drain-Source On-Resistance	$V_{GS} = 10V, I_D = 20A$	R _{DS(ON)}		56	70	mΩ
Dynamic Characteristics Note 3						
Input Capacitance	V_{DS} = 100V, V_{GS} = 0V, f = 1MHz	CISS		2905		рF
Output Capacitance	V_{DS} = 100V, V_{GS} = 0V, f = 1MHz	Coss		160		рF
Reverse Transfer Capacitance	V_{DS} = 100V, V_{GS} = 0V, f = 1MHz	C _{RSS}		5		pF
Switching Characteristics Note 3						
Turn-On Delay Time	V_{DD} = 520V, V_{GS} = 10V, I_{D} = 10A, $R_{G(\text{ext})}$ = 10 Ω	t _{D(ON)}		42		ns
Turn-On Rise Time	V_{DD} = 520V, V_{GS} = 10V, I_{D} = 10A, $R_{G(\text{ext})}$ = 10 Ω	t _R		21		ns
Turn-Off Delay Time	V_{DD} = 520V, V_{GS} = 10V, I_{D} = 10A, $R_{G(\text{ext})}$ = 10 Ω	t _{D(OFF)}		124		ns
Turn-Off Fall Time	V_{DD} = 520V, V_{GS} = 10V, I_{D} = 10A, $R_{G(ext)}$ = 10 Ω	t _F		5		ns
Total Gate Charge	V_{DS} = 520V, V_{GS} = 10V, I_D = 10A	Q _G		79		nC
Gate Source Charge	V_{DS} = 520V, V_{GS} = 10V, I_{D} = 10A	Q _{GS}		18		nC
Gate Drain Charge	V_{DS} = 520V, V_{GS} = 10V, I_{D} = 10A	\mathbf{Q}_{GD}		25		nC
Drain-Source Diode Characteristics a	nd Maximum Ratings					
Drain-Source Diode Forward Current		Is			45	A
Drain-Source Diode Forward Voltage Note 2	V _{GS} = 0V, I _S = 20A	V_{SD}			1.5	V
Reverse Recovery Time	V_R = 400V, I_F = 23A, di/dt = 100A/µs	t _{RR}		386		ns
Reverse Recovery Charge	V_R = 400V, I_F = 23A, di/dt = 100A/µs	Q _{RR}		8.7		μC
Peak Reverse Recover Current	V _R = 400V, I _F = 23A, di/dt = 100A/µs	I _{RR}		44.2		А

Notes

1: Repetitive Rating: Pulse width limited by maximum junction temperature

2: Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

3: Guaranteed by design, not subject to production testing.

4: Limited only by maximum temperature allowed.

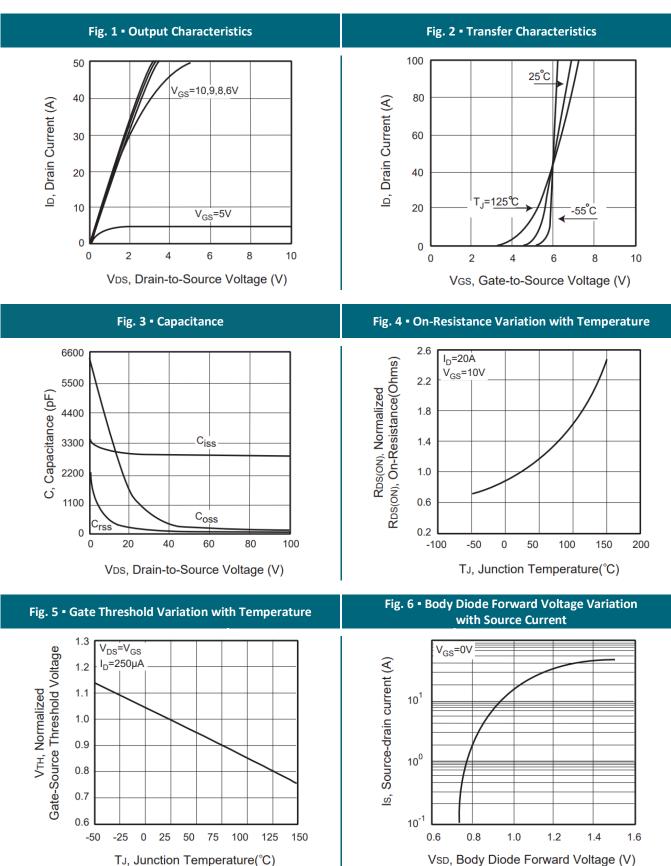
- 5: Pulse width limited by safe operating area.
- 6: $L = 37.5 \text{mH}, I_{AS} = 4A, V_{DD} = 60V, R_G = 25\Omega$, Starting T_J = 25°C



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CET MOS

REFERENCE DATA ▲ TYPICAL DEVICE PERFORMANCE



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REFERENCE DATA A TYPICAL DEVICE PERFORMANCE

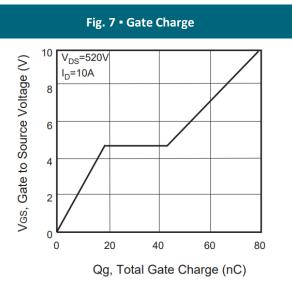


Fig. 9 - Breakdown Voltage Variation vs. Temperature

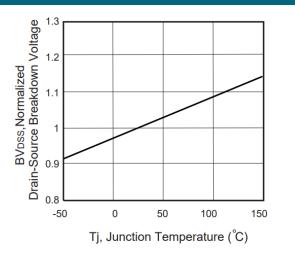
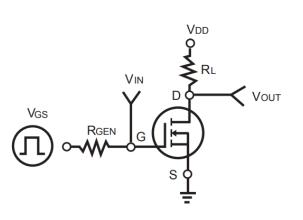


Fig. 10 • Switching Test Circuit



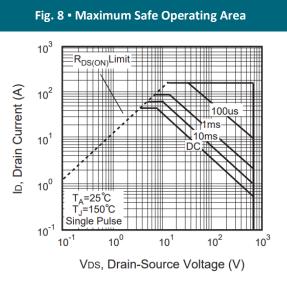
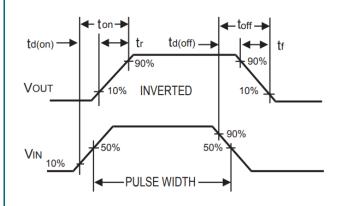


Fig. 11 - Switching Waveforms



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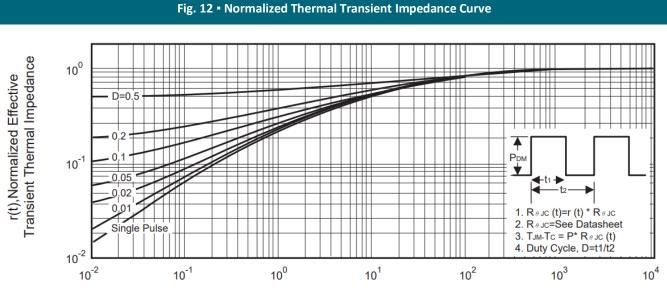
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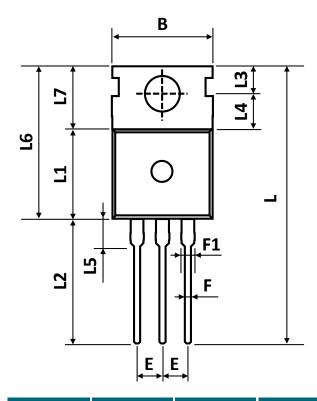


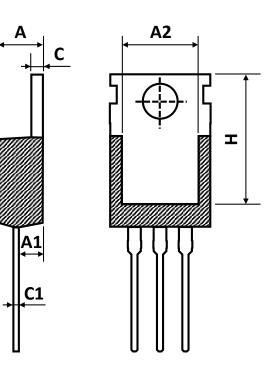
Square Wave Pulse Duration (msec)



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PACKAGE OUTLINE





Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)
А	4.43	4.53	4.63
A1	2.30	2.40	2.50
A2	7.70	7.90	8.10
В	9.80	10.00	10.20
С	1.25	1.30	1.40
C1	0.45	0.50	0.60
D	3.45	3.60	3.70
E	2.45	2.54	2.60
F	0.70	0.80	0.95
F1	1.15	1.33	1.50
L	26.80	28.80	30.80
L1	9.20	9.30	9.40
L2	12.80	13.10	13.40
L3	2.70	2.80	2.90
L4	3.50	3.70	3.80
L5	2.60	2.90	3.20
L6	15.40	15.80	16.20
L7	6.20	6.50	6.80
Н	12.95	13.25	13.55

ORDERING INFORMATION

Part Number	Package	Packing	Tube Qty.	Inner Box Qty.	Outer Box Qty.
CEP45N65S	TO-220-3L	Tube	50pcs	1,000pcs	4,000pcs
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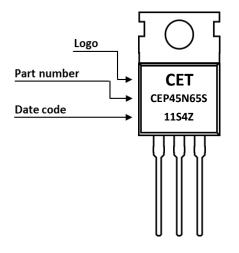
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PART MARKING



DATE CODE

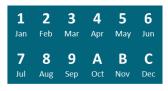
Example: 11S4Z



| Product Type Z: Pb-free G: Green Product

	Coding list for "Day"								
1	2	3	4	5	6	7	8	9	A
01	02	03	04	05	06	07	08	09	10
B	C	D	E	F	G	H	 	J	K
11	12	13	14	15	16	17	18	19	20
L	M	N	0	P	Q	R	S	T	U
21	22	23	24	25	26	27	28	29	30
V 31									

Coding list for "Month"



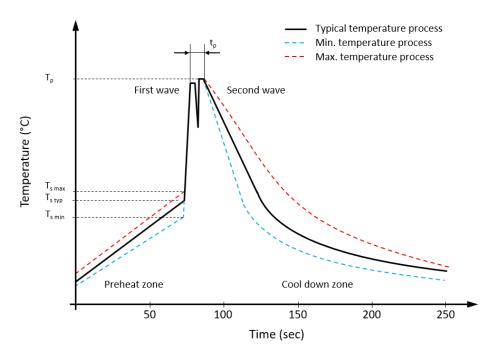
Coding list for "Year"







RECOMMENDED WAVE SOLDERING PROFILE A THT PACKAGE



Classification wave soldering profile ▲ Refer to EN 61760-1: 2006

Profile Features		Value 🛦 Sn-Pb Assembly	Value 🔺 Pb-free Assembly
Preheat temperature min.	T_{smin}	100 °C	100 °C
Preheat temperature typical	T _{s typ}	120 °C	120 °C
Preheat temperature max.	$T_{s max}$	130 °C	130 °C
Preheat time t_s from $T_{s min}$ to $T_{s max}$	ts	70 seconds	70 seconds
Peak temperature	Tp	235 °C to 260 °C	245 °C to 260 °C
Time of actual peak temperature	t _p	Max. 10 seconds Max. 5 second each wave	Max. 10 seconds Max. 5 second each wave
Ramp-down date min.		~ 2 °C/second	~ 2 °C/second
Ramp-down rate typical		~ 3.5 °C/second	~ 3.5 °C/second
Ramp-down rate max.		~ 5 °C/second	~ 5 °C/second
Time 25°C to 25°C		4 minutes	4 minutes



REVISION TABLE

Revision	Date	Status	Notes
001	30/09/2022	Initial release	Initial publication

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